

Reset IC with Latch and MUX

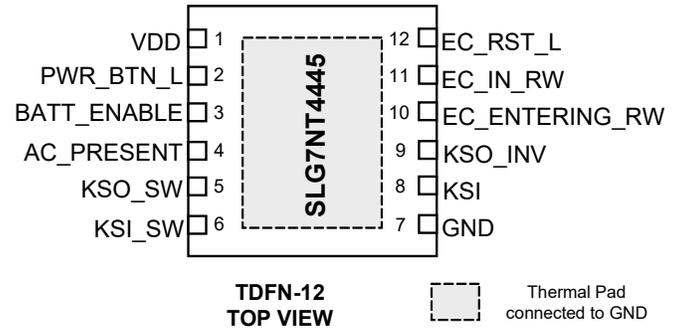
General Description

Renesas GreenPAK 2 SLG7NT4445 is a low power and small form device. The SoC is housed in a 2.5mm x 2.5mm TDFN package which is optimal for using with small devices.

Features

- Low Power Consumption
- Dynamic Voltage Supply Range
- RoHS Compliant / Halogen-Free
- Pb-Free TDFN-12 Package
- MSL1

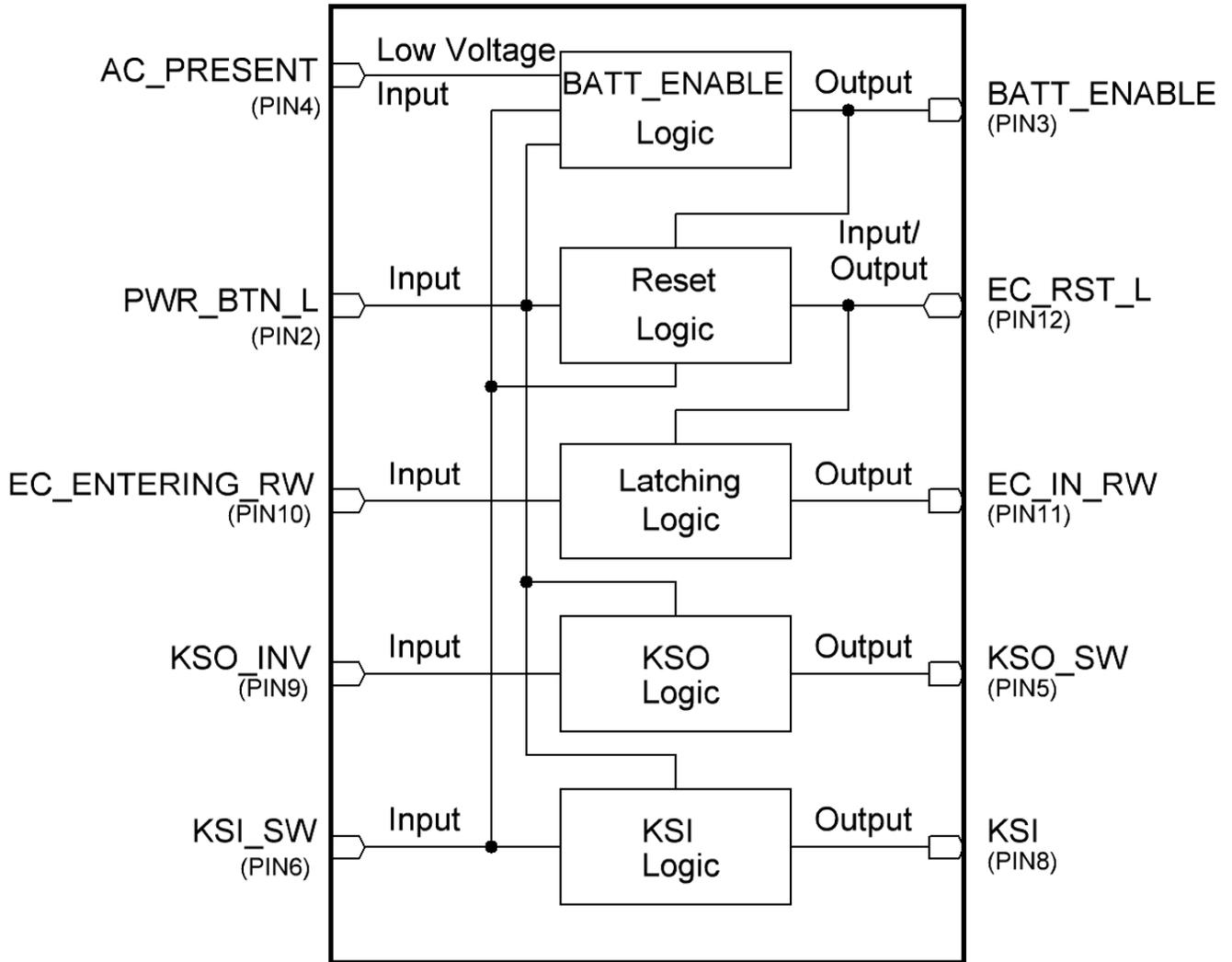
Pin Configuration



Output Summary

- 1 Output — Push Pull 1X
- 4 Outputs — Open Drain NMOS 1X

Block Diagram





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Pin Configuration

Pin #	Pin Name	Type	Pin Description
1	VDD	PWR	Supply Voltage
2	PWR_BTN_L	Digital Input	Digital Input with Schmitt trigger
3	BATT_ENABLE	Digital Output	Open Drain NMOS 1X
4	AC_PRESENT	Digital Input	Low Voltage Digital Input
5	KSO_SW	Digital Output	Open Drain NMOS 1X
6	KSI_SW	Digital Input	Digital Input with Schmitt trigger
7	GND	GND	Ground
8	KSI	Digital Output	Open Drain NMOS 1X
9	KSO_INV	Digital Input	Digital Input with Schmitt trigger
10	EC_ENTERING_RW	Digital Input	Digital Input with Schmitt trigger
11	EC_IN_RW	Digital Output	Open Drain NMOS 1X
12	EC_RST_L	Bi-directional	Digital Input with Schmitt trigger / Push Pull 1X
Exposed Bottom Pad	Exposed Bottom Pad	GND	Ground

Ordering Information

Part Number	Package Type
SLG7NT4445V	V = TDFN-12
SLG7NT4445VTR	VTR = TDFN-12 - Tape and Reel (3k units)



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Absolute Maximum Conditions

Parameter	Min.	Max.	Unit
V _{HIGH} to GND	-0.3	7	V
Voltage at input pins	-0.3	7	V
Current at input pin	-1.0	1.0	mA
Storage temperature range	-65	150	°C
Junction temperature	--	150	°C

Electrical Characteristics

(@ 25°C, unless otherwise stated)

Symbol	Parameter	Condition/Note	Min.	Typ.	Max.	Unit
V _{DD}	Supply Voltage		1.71	--	5.5	V
T _A	Operating Temperature		-40	25	85	°C
I _Q	Quiescent Current	Static inputs and outputs	--	1	--	μA
I _A	Active Current	Static inputs and outputs	--	15	--	μA
V _O	Maximal Voltage Applied to any PIN in High-Impedance State		--	--	VDD	V
I _O	Maximal Average or DC Current (note 1)	Per Each Chip Side	--	--	24	mA
V _{IH}	HIGH-Level Low Voltage Input Voltage	Logic Input with Schmitt Trigger, at VDD=1.8V	1.35	--	VDD	V
		Low-Level Logic Input, at VDD=1.8V	1.1	--	VDD	
		Logic Input with Schmitt Trigger, at VDD=3.3V	2.3	--	VDD	
		Low-Level Logic Input, at VDD=3.3V	1.5	--	VDD	
		Logic Input with Schmitt Trigger, at VDD=5.0V	3.2	--	VDD	
		Low-Level Logic Input, at VDD=5.0V	1.7	--	VDD	
V _{IL}	LOW-Level Low Voltage Input Voltage	Logic Input with Schmitt Trigger, at VDD=1.8V	--	--	0.45	V
		Low-Level Logic Input, at VDD=1.8V	--	--	0.50	
		Logic Input with Schmitt Trigger, at VDD=3.3V	--	--	0.92	
		Low-Level Logic Input, at VDD=3.3V	--	--	0.66	
		Logic Input with Schmitt Trigger, at VDD=5.0V	--	--	1.3	



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		Low-Level Logic Input, at VDD=5.0V	--	--	0.77	
I _{IH}	HIGH-Level Input Current	Logic Input Pins; V _{IN} = VDD	-1.0	--	1.0	μA
I _{IL}	LOW-Level Input Current	Logic Input Pins; V _{IN} = 0V	-1.0	--	1.0	μA
V _{OH}	HIGH-Level Output Voltage (note 1)	Push Pull, I _{OH} = 100uA, 1X Driver, at VDD=1.8 V	1.66	--	--	V
		Push Pull, I _{OH} = 700uA, 1X Driver, at VDD=1.8 V	1.21	--	--	
		Push Pull, I _{OH} = 3mA, 1X Driver, at VDD=3.3 V	2.1	--	--	
		Push Pull, I _{OH} = 5mA, 1X Driver, at VDD=5.0 V	3.6	--	--	
		Push Pull, I _{OH} = 8mA, 1X Driver, at VDD=5.0 V	2.9	--	--	
V _{OL}	LOW-Level Output Voltage (note 1)	Push Pull, I _{OL} = 100uA, 1X Driver, at VDD=1.8 V	--	--	0.040	V
		Push Pull, I _{OL} = 700uA, 1X Driver, at VDD=1.8 V	--	--	0.415	
		Open Drain, I _{OL} = 5mA, 1X Driver, at VDD=1.8 V	--	--	0.340	
		Push Pull, I _{OL} = 3mA, 1X Driver, at VDD=3.3 V	--	--	0.81	
		Open Drain, I _{OL} = 20mA, 1X Driver, at VDD=3.3 V	--	--	0.605	
		Push Pull, I _{OL} = 5mA, 1X Driver, at VDD=5.0 V	--	--	0.85	
		Push Pull, I _{OL} = 8mA, 1X Driver, at VDD=5.0 V	--	--	1.2	
		Open Drain, I _{OL} = 20mA, 1X Driver, at VDD=5.0 V	--	--	0.36	
I _{OL}	LOW-Level Output Current (note 1)	Push Pull, V _{OL} = 0.15V, 1X Driver, at VDD=1.8 V	0.34	--	--	mA
		Open Drain, V _{OL} = 0.15V, 1X Driver, at VDD=1.8 V	2.72	--	--	
		Push Pull, V _{OL} = 0.4V, 1X Driver, at VDD=3.3 V	1.836	--	--	
		Open Drain, V _{OL} = 0.4V, 1X Driver, at VDD=3.3 V	14.688	--	--	
		Push Pull, V _{OL} = 0.4V, 1X Driver, at VDD=5.0 V	2.745	--	--	



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		Open Drain, $V_{OL} = 0.4V$, 1X Driver, at $VDD=5.0V$	21.96	--	--	
R_{PULL_UP}	Internal Pull Up Resistance	Pull up on PINs 6, 12	35	50	65	k Ω
R_{PULL_DOWN}	Internal Pull Down Resistance	Pull down on PIN10	35	50	65	k Ω
		Pull down on PIN9	210	300	390	
T_{DLY0}	Delay0 Time	At temperature 25°C	4.13	5	5.88	ms
T_{DLY1}	Delay1 Time	At temperature 25°C	8.27	10	11.7	ms
T_{DLY2}	Delay2 Time	At temperature 25°C	5	--	7.042	s
T_{DLY3}	Delay3 Time	At temperature 25°C	60	--	127	μ s
T_{SU}	Start up Time	After VDD reaches 1.6V level	--	7	--	ms

1. Guaranteed by Design.



Description

This device is a reset IC with one shot function, internal Latching system, level shifter and multiplexor. The reset (active LOW) occurs when both PWR_BTN_L (PIN2) and KSI_SW (PIN6) are LOW. PWR_BTN_L (PIN2) has 5ms deglitch delay on its line. Also reset logics contains one more 100µs deglitch delay is used. The signal from this delay goes to 10ms one-shot system that creates 10ms LOW pulse on reset event. If PWR_BTN_L and KSI_SW are LOW, and AC_PRESENT (PIN4) transitions from HIGH to LOW, these three conditions will latch the BATT_ENABLE (PIN3) LOW for 5 seconds minimum. During this EC_RST_L will be asserted and EC_IN_RW will go LOW as well.

EC_RST_L is configured to be bidirectional, so it will operate as digital input with Schmitt trigger or as Low Level Digital Output.

Also SLG7NT4445 includes latching system. Its inputs are EC_RST_L and EC_ENTERING_RW. EC_IN_RW is an output configured as open drain. This system is initialized with logic HIGH on its output. It is latched LOW when EC_RST_L goes LOW until EC_ENTERING_RW goes HIGH.

Multiplexing system in this device follow the logic:

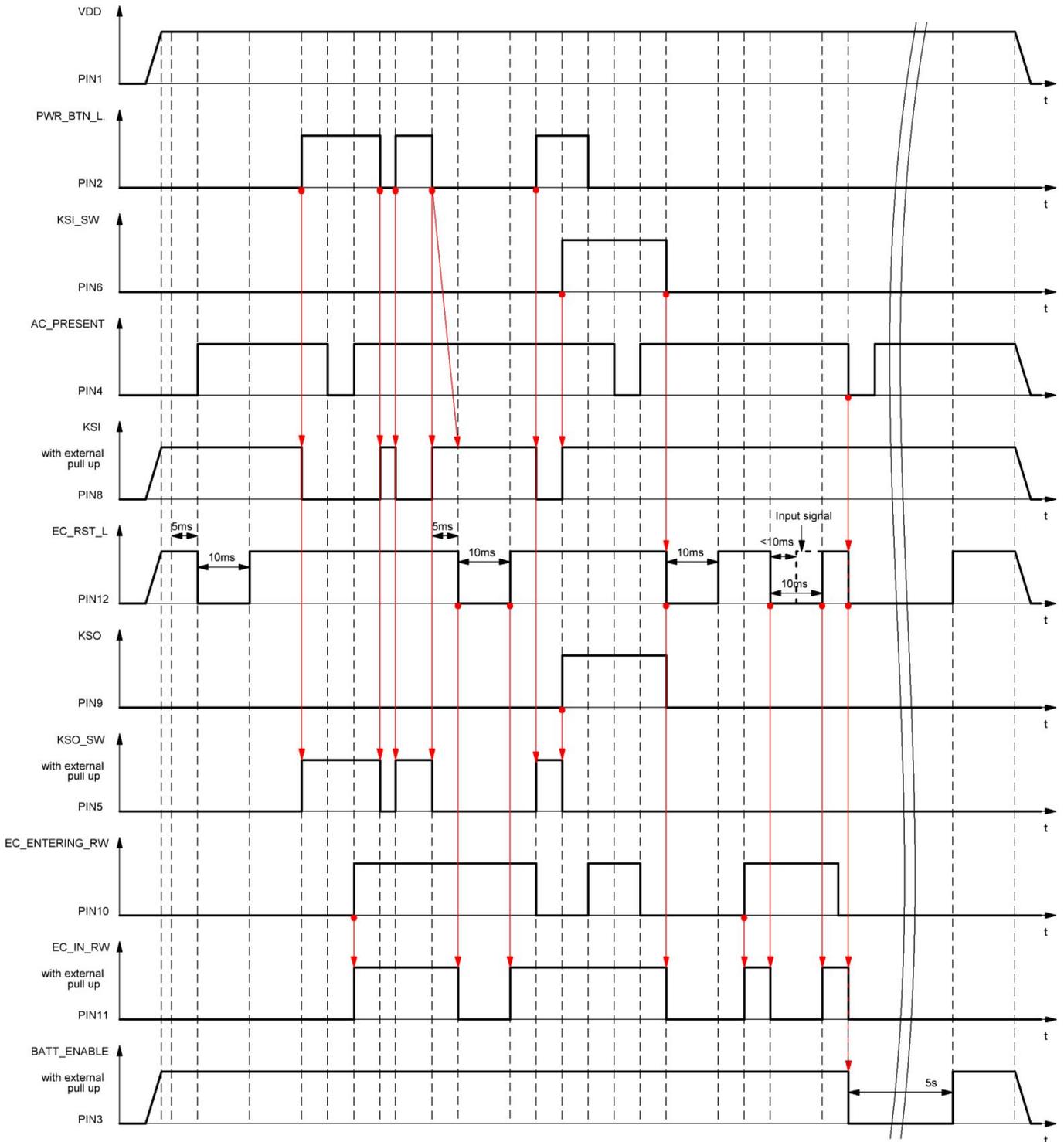
$KSO_SW = PWR_BTN_L \ \&\& \ !KSO_INV$

$KSI = !(PWR_BTN_L) \ | \ KSI_SW$

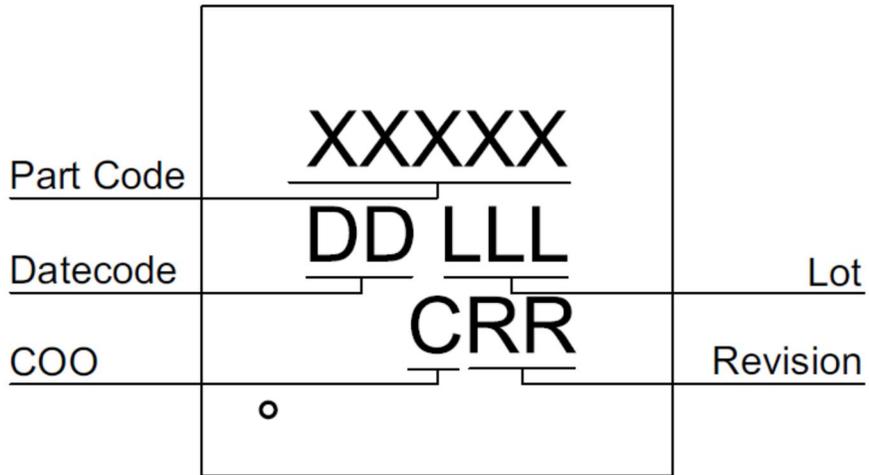
If the AC_PRESENT / BATTERY_ENABLE functionality is not needed, BATTERY_ENABLE can be left floating but AC_PRESENT should be tied low.

All pins are in a high impedance state until the chip has powered up.

Timing Diagram



Package Top Marking



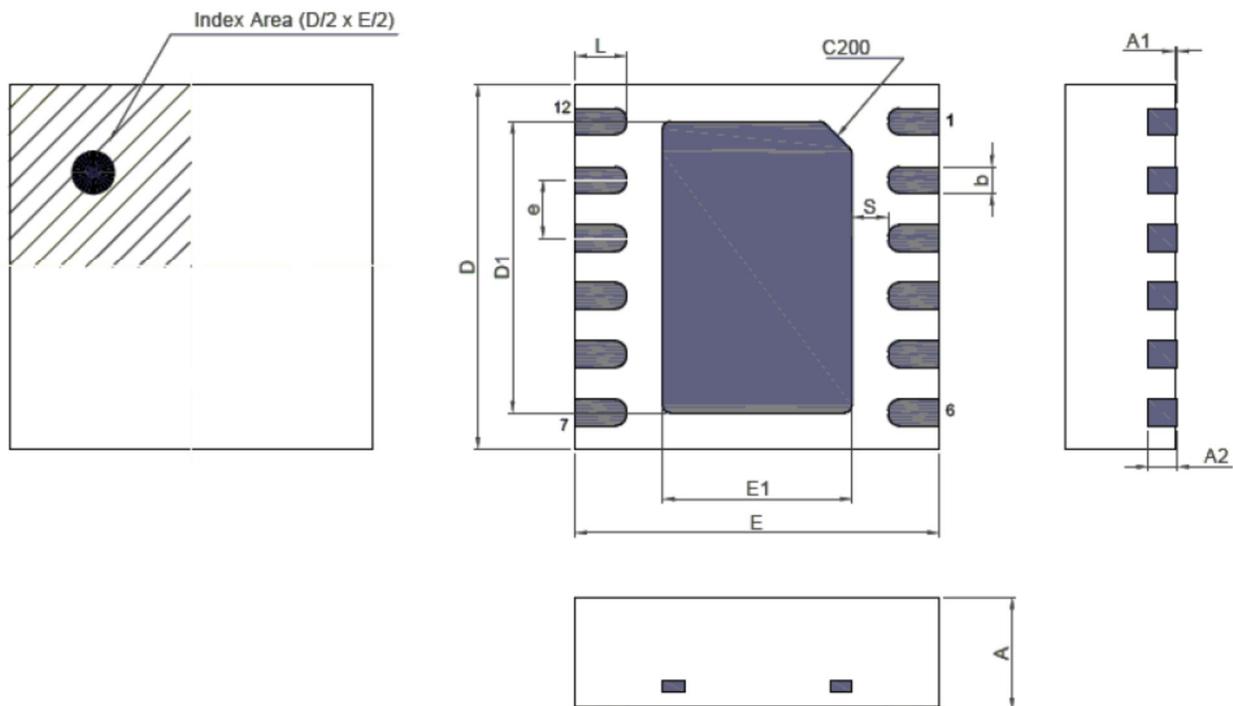
- XXXXX – Part ID Field: identifies the specific device configuration
- DD – Date Code Field: Coded date of manufacture
- LLL – Lot Code: Designates Lot #
- C – COO: Specifies Country of Origin
- RR – Revision Code: Device Revision

Datasheet Revision	Programming Code Number	Locked Status	Part Code	Revision	Date
1.03	002	L	4445V	AB	02/25/2022

The IC security bit is locked/set for code security for production unless otherwise specified. Revision number is not changed for bit locking.

Package Drawing and Dimensions

12 Lead TDFN Package
JEDEC MO-252, Variation 2525E



Unit: mm

Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
A	0.70	0.75	0.80	D1	1.95	2.00	2.05
A1	0.005	-	0.060	E1	1.25	1.30	1.35
A2	0.15	0.20	0.25	e	0.40 BSC		
b	0.13	0.18	0.23	L	0.30	0.35	0.40
D	2.45	2.50	2.55	S	0.18	-	-
E	2.45	2.50	2.55				

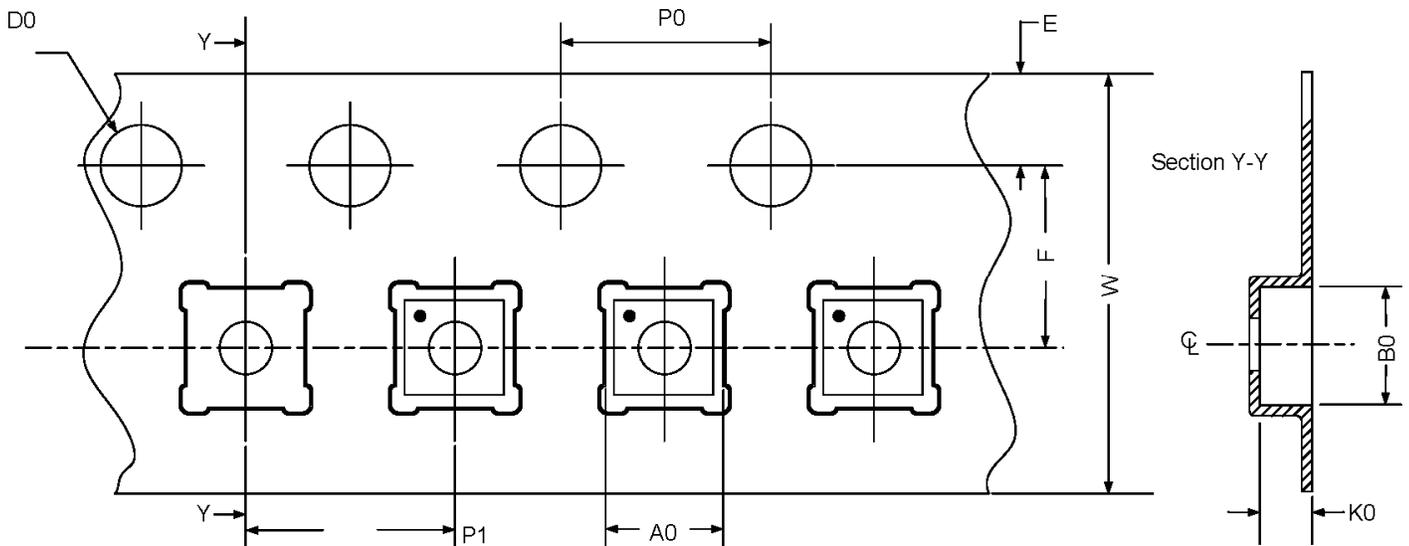
Tape and Reel Specification

Package Type	# of Pins	Nominal Package Size (mm)	Max Units		Reel & Hub Size (mm)	Trailer A		Leader B		Pocket (mm)	
			per reel	per box		Pockets	Length (mm)	Pockets	Length (mm)	Width	Pitch
TDFN 12L 2.5x2.5mm 0.4P Green	12	2.5x2.5x0.75	3000	3000	178/60	42	168	42	168	8	4

Carrier Tape Drawing and Dimensions

Package Type	Pocket BTM Length (mm)	Pocket BTM Width (mm)	Pocket Depth (mm)	Index Hole Pitch (mm)	Pocket Pitch (mm)	Index Hole Diameter (mm)	Index Hole to Tape Edge (mm)	Index Hole to Pocket Center (mm)	Tape Width (mm)
	A0	B0	K0	P0	P1	D0	E	F	W
TDFN 12L 2.5x2.5mm 0.4P Green	2.75	2.75	1.05	4	4	1.55	1.75	3.5	8

Refer to EIA-481 Specifications



Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 4.6875 mm³ (nominal). More information can be found at www.jedec.org.

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